## FOR UTILITY/DESIGN CIP/PCT NATIONAL/PLANT ORIGINAL/SUBSTITUTE/SUPPLEMENTAL **DECLARATIONS**

A. 🛛 is attached hereto.

## RULE 63 (37 C.F.R. 1.63) **DECLARATION AND POWER OF ATTORNEY** FOR PATENT APPLICATION IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

PW **FORM** 

As a below named inventor, I hereby declare that my residence, post office address and citizenship are as stated below next to my name, and I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the <a href="INVENTION ENTITLED">INVENTION ENTITLED</a>

METHOD FOR PLANARIZING A SURFACE OF A SEMICONDUCTOR WAFER

the specification of which (CHECK applicable BOX(ES))

BOX(ES) →	В. 🗆 v	was filed on			U.S. Appli	cation No.	1	
<b>→</b> →	C. 🗆	was filed as PCT II	nternational	Application N	lo. PCT/	1	on	
and (if applicable	to U.S.	or PCT application	) was amended	on				
above. I acknowled	ge the d	uty to disclose all inform	nation known to m	ne to be material to preion application(s	patentability s) for patent of	as defined in 37 C or inventor's certific	ate, or 365(a) of any PC	oted below, I hereby claim T International
Application which de	esignateo	t at least one other cou	untry than the Unit me or my assign	ed States, listed be ee disclosing the s	elow and hav ubject matter	e also identified be · claimed in this ap	low any foreign applicati	on for patent or inventor's ing date (1) before that of
PRIOR FOREIGN	N APPI	ICATION(S)			Date fi	rst <u>Laid-</u>	Date Patented	
Number		ountry	Day/MONTH/	<u>ear Filed</u>	open	or Published	or Granted	Priority NOT Claimed
10-2003-0060850				•				
If more prior foreign applications, X box at bottom and continue on attached page.  Except as noted below, I hereby claim domestic priority benefit under 35 U.S.C. 119(e) or 120 and/or 365(c) of the indicated United States applications listed below and PCT international applications listed above or below and, if this is a continuation-in-part (CIP) application, insofar as the subject matter disclosed and claimed in this application is in addition to that disclosed in such prior applications, I acknowledge the duty to disclose all information known to me to be material to patentability as defined in 37 C.F.R. 1.56 which became available between the filing date of each such prior application and the national or PCT international filing date of this application:								
•	NISIO	NAL, NONPROVIS	IONAL AND/OF	R PCT APPLICA	TION(S)		Status	Priority NOT Claimed
Application No.	(series	code/serial no.)	Day/MC	NTH/Year Filed	1	pending, a	bandoned, patente	
I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.								
And I hereby appoint Pillsbury Winthrop LLP, Intellectual Property Group, telephone number (703) 905-2000 (to whom all communications are to be directed), and persons of that firm who are associated with USPTO Customer No. 909 (see below label) individually and collectively my attorneys to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith and with the resulting patent, and I hereby authorize them to delete from that Customer No. names of persons no longer with their firm, to add new persons of their Firm to that Customer No., and to act and rely on instructions from and communicate directly with the person/assignee/attorney/firm/ organization who/which first sends/sent this case to them and by whom/which I hereby declare that I have consented after full disclosure to be represented unless/until I instruct the above Firm and/or an attorney of that Firm in writing to the contrary.								
disclosure to be rep	oresente	d unless/until I instruct	the above Firm ai	nd/or an attorney o	•	Willing to the conti	ary.	
*00909*								
	LY FOR		007	00707			(Customer No. for communications)	
PILLSBURY WINTHROP 00909								
(1) INVENTOR'S SIGNATURE: J. Hyong Lee December 3, 2003								
	1	ATURE: OL (	75.9	Myong	Lee			
Name	Ji_	Circl		Middle Initial	1 200		Family Name	
		First			Verse		Republic of I	Corea
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Mailing Address 891-10 Daechi-dong, Gangnam-gu, Seoul, Korea								
(include Zip Cod	ie)					<del></del>		
(2) INVENTOR'S SIGNATURE: Date:								
Name							·	
	<u> </u>	First		Middle Initial			Family Name	
Residence								
		City			State/Foreig	n Country	C	ountry of Citizenship
Mailing Address								
(include Zip Cod							· ·	
<ul> <li>☐ FOR ADDITIONAL INVENTORS see attached page.</li> <li>☐ See <u>additional foreign priorities</u> on attached page (incorporated herein by reference).</li> </ul>								
Atty. Dkt. No. P								
						•		VI#)